

PARALLEL PROCESSING SYSTEM (PPS) APPLICATION NOTE

TDI (10371) STAND-ALONE

This application note describes the connections required to use the Telecommunications Data Interface for stand-alone serial operation. The A and B clocks required for the TDI can be easily supplied using Rockwell's Clock Generator (Part No. 10706) with control straps set for 256 KHz and using a 3.579545 MHz color TV crystal.

The TDI connections for serial operation are listed below. All unlisted pins must be left open-circuit.

Pin 06, WIO - Connect pull up of 68K to 100K ohms to VSS.

Pin 10, ACKI - Connect pull up of 68K to 100K ohms to VSS.

Pin 11, VSS - +5V Power Supply.

Pin 12, PINH - Strap to VSS (+5V).

Pin 13, BRS - Strap to VSS (+5V).

Pin 14, VDD - -12V Power Supply; decouple with 0.1 microfarad ceramic capacitor at the chip

Pin 15, CLKA - System Clock. Must be 256 KHz from PPS or 10706 clock chip

Pin 16, CLKBP - System Clock. 10706 is strapped: Pin 9 = VSS

Pin 8 = VDD Pin 7 = VSS

Pin 18, RI - Receiver Input, TTL threshold, edges detected.

Drive with unloaded CMOS or unloaded TTL driver.

If driving with OP AMP, use diode clamp to +4.5V.

Pin 20, CDS - Carrier Detect Select Strap, VSS = 8 ms turn-on, nominal, with a "Marking" input signal.

Pin 21, RSDO - Receiver Serial Data Output; TTL "1" = Mark,
TTL "0" = Space. Connect pull down of 6.8K
ohms to VDD (-12V).

Pin 22, RCD - Receiver Carrier Detect Output, TTL "1" = On, TTL "0" = Off. Connect pull down of 6.8K ohms to VDD (-12V).

Pin 23, 10MS - Ten-Millisecond Square Wave, 50 Hz, connect pull down of 6.8K ohms to VDD (-12V). Leave open if unused.

Pin 25, MS - Mode Select Strap; VDD = Serial.

Pin 26, TSDI - Transmitter Serial Data Input; TTL "1" = Mark, TTL "0" = Space. Drive with unloaded CMOS or unloaded TTL Driver.

Pin 28, VSEL 2 - No connection.

Pin 29, VSEL 1 - Ground; return for Transmitter Output Drivers.

Pin 30, FS - Frequency Select Strap; VDD = Wider Range (Bell 202).

Pin 31, SPO - From Special Power On Reset Circuit.

Pin 32, OPS - Strap to VSS (+5V).

Pin 33, TO4 - Connect through 16.1K ohms to Summing Node.

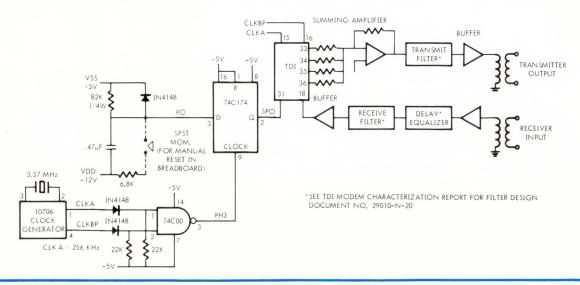
Pin 34, TO3 - Connect through 10.0K ohms to Summing Node.

Pin 35, TO2 - Connect through 10.0K ohms to Summing Node.

Pin 36, TO1 - Connect through 16.1K ohms to Summing Node.

Pin 37, RQS - Request to Send Input; TTL "1" = Transmitter On, TTL "0" = Transmitter Off. Drive with unloaded CMOS or unloaded TTL Driver.

The SPO input must be toggled after power on. The circuit below simulates the action of the PPS CPU during power-on reset.



DUE	BLARSE	POLADITY	FUNCTION	DIN	NASAE	POLARITY	FUNCTION
PIN	NAME	POLARITY		PIN	NAME		
1	ID8	$\pm 5V = 0$ $-12V = 1$	Instruction Data Bus	22	RCD	+5V = 1 0V = 0	Receiver Carrier Detect Output (+5V = 1 = Carrier, Detect On). Connect pull down of 6.8K ohms to VDD (-12V)
2	SL3	+5V = 0 -12V = 1	Address Strap	23	10MS	+5V = 1 0V = 0	10 ms Square Wave (50 Hz) Output, Connect pull down of 6,8K ohms to VDD
3	ID7	+5V = 0 -12V = 1	Instruction Data Bus	24	1000		(-12V)
4	SL2	+5V = 0 -12V = 1	Address Strap	24	TSDO	+5V = 1 0V = 0	Transmitter Serial Data Output (UART Output). Connect pull down of 6.8K ohms to VDD (-12V)
5	ID6	+5V = 0 -12V = 1	Instruction Data Bus	25	MS	+5V = PPS Mode -12V = External	Mode Select Strap
6	WIO	+5V = 0 $-12V = 1$	Memory Write/Input-Output Enable, PPS Input	26	T SDI	Mode +5V = 1	Transmitter Serial Data Input (+5V = 1
7	ID5	+5V = 0 -12V = 1	Instruction Data Bus			0V = 0	= Mark if MS = -12V). Drive with unloaded CMOS or unloaded ITL Driver
8	SL1	+5V = 0 -12V = 1	Address Strap	27	INT2	+5V = Interrupt Request	Interrupt Request Output
9	ACKO	+5V = 0 -12V = 1	Interrupt Acknowledge Output			-12V = No Request	Connect pull down of 6.8K ohms to VDD
10	ACKI	+5V = 0	Interrupt Acknowledge Input	28	No Con	ı	
11	VSS	-12V = 1 +5V	Power Supply	29	VSEL 1	0V or - 5V	Return Supply for Transmitter Output Pins 33, 34, 35, 36 (May be -12V).
12	PINH	+5V = with parity	Parity Inhibit Strap				Decouple with 0.1 microfarad ceramic at chip
		-12V = without parity		30	FS	+5V = CCITT -12V = BELL	Modem Frequency Select Strap
13	BRS	+5V = 1200 Baud -12V = 9600 Baud	Baud Rate Select Strap for UART only (Modem will only operate at 0-1200 Baud)	31	SPO	+5V = Normal -12V = Reset	Synchronized Power On Reset (from CPU)
14	VDD	-12V	Power Supply. Decouple with 0.1 micro- farad ceramic at chip	32	OPS	+5V = Odd -12V = Even	Odd Parity Select Strap
15 16	CLKA	$ \begin{vmatrix} +5V &= 0 \\ -12V &= 1 \end{vmatrix} $ $ +5V &= 0 $	System Clock must be 256 KHz from PPS or 10706 Clock Chip System Clock	33	T O4	+5V ≈ 0 VSEL1 = 1	Modulator Output No. 4. +5V = 0 = Off State. Connect through 16.1K ohms to Summing Node.
		-12V = 1	10706 is strapped: Pin 9 = VSS Pin 8 = VDD Pin 7 = VSS	34	103	+5V = 0 VSEL1 = 1	Modulator Output No. 3. +5V = 0 = Off State. Connect through 10.0K ohms to Summing Node.
17	Test 8	+5V = 1 0V = 0	Chip Test. Output of no use in System. Connect pull down of 6.8K ohms to VDD, or leave open	35	TO2	+5V = 0 VSEL1 = 1	Modulator Output No. 2. +5V = 0 = Off State. Connect through 10.0K ohms to Summing Node.
18	RI	+5V = 1 $0V = 0$	Receiver Input, TTL threshold, edges detected. Drive with unloaded CMOS or unloaded	36	101	+5V = 0 VSEL1 = 1	Modulator Output No. 1. +5V = 0 = Off State. Connect through 16.1K ohms to Summing Node.
19	R SDI	+5V = 1	TTL Driver. If driving with OP AMP, use Diode Clamp to +4.5V. Receiver Serial Data Input (UART Input	37	RQS	+5V = On 0V = Off	Transmitter On/Off Control if MS = -12V. Drive with unloaded CMOS or
,,		0V = 0	if MS = -12V). Drive with unloaded CMOS or unloaded TTL Driver	38	ID1	+5V = 0	unloaded TTL Driver. Instruction Data Bus
20	CDS	+5V = Normal Delay -12V = Short	Carrier Detect Strap	39	ID2	-12V = 1 +5V = 0 -12V = 1	Instruction Data Bus
0.1	DCD C	Delay	Parations facial Date Original	40	ID3	+5V = 0	Instruction Data Bus
21	RSDO	$ \begin{vmatrix} +5V = 1 \\ 0V = 0 \end{vmatrix} $	Receiver Serial Data Output (Demodulator Output). Connect pull down of 6.8K ohms to VDD (-12V)	41	ID4	-12V = 1 $+5V = 0$	Instruction Data Bus
				42	SL4	-12V = 1 +5V = 0 -12V = 1	Address Strap

^{*} SUPERSEDES ALL PREVIOUS INFORMATION

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